



**Hittite**  
MICROWAVE PRODUCTS  
FROM ANALOG DEVICES

# Analog Devices Welcomes Hittite Microwave Corporation



**THIS PAGE INTENTIONALLY LEFT BLANK**

### Typical Applications

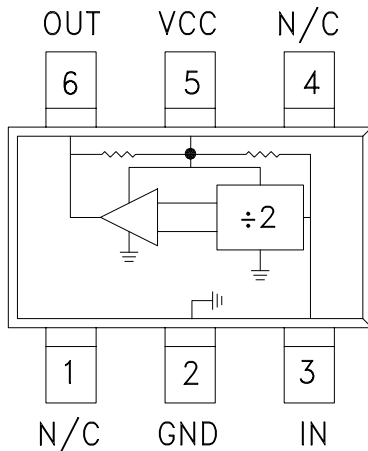
Prescaler for DC to C band PLL applications:

- UNII, point-to-point, and VSAT radios
- 802.11a and HiperLAN WLAN
- Fiber optic
- Cellular / 3G infrastructure

### Features

- Ultra low SSB phase noise: -148 dBc/Hz
- Single-ended I/O's
- Output power: -3 dBm to -9 dBm
- Single DC supply: +3V @ 42 mA
- 9 mm<sup>2</sup> ultra small package: SOT26

### Functional Diagram



### General Description

The HMC432(E) is a low noise divide-by-2 static divider utilizing InGaP GaAs HBT technology in ultra small surface mount SOT26 plastic packages. This device operates from DC (with a square wave input) to 8 GHz input frequency with a single +3V DC supply. Single-ended inputs and outputs reduce component count and cost. The low additive SSB phase noise of -148 dBc/Hz at 100 kHz offset helps the user maintain good system noise performance.

### Electrical Specifications, $T_A = +25^\circ\text{C}$ , 50 $\Omega$ System, $V_{CC} = +3\text{V}$

Parameter	Conditions	Min.	Typ.	Max.	Units
Input frequency	Sine wave input [1] [2]			8	GHz
Input power range	$F_{in} = 0.2 \text{ GHz to } 0.4 \text{ GHz}$	-4		+11	dBm
	$F_{in} = 0.4 \text{ GHz to } 0.6 \text{ GHz}$	-10		+12	
	$F_{in} = 0.6 \text{ GHz to } 1.0 \text{ GHz}$	-15		+15	
	$F_{in} = 1 \text{ GHz to } 7 \text{ GHz}$	-12		+12	
	$F_{in} = 7 \text{ GHz to } 8 \text{ GHz}$	-4		+10	
Output power	$F_{in} = 4 \text{ GHz}$	-6	-3		dBm
	$F_{in} = 8 \text{ GHz}$	-12	-9		dBm
Reverse leakage	RF output terminated, $F_{in} = 4 \text{ GHz}$ , $P_{in} = 0 \text{ dBm}$		-30		dBm
SSB phase noise (100 kHz offset)	$P_{in} = 0 \text{ dBm}$ , $F_{in} = 4 \text{ GHz}$		-148		dBc/Hz
Output transition time	$P_{in} = 0 \text{ dBm}$ , $F_{out} = 882 \text{ MHz}$		145		ps
Supply current ( $I_{CC}$ )	$V_{CC} = 3.0 \text{ V}$		42	56	mA

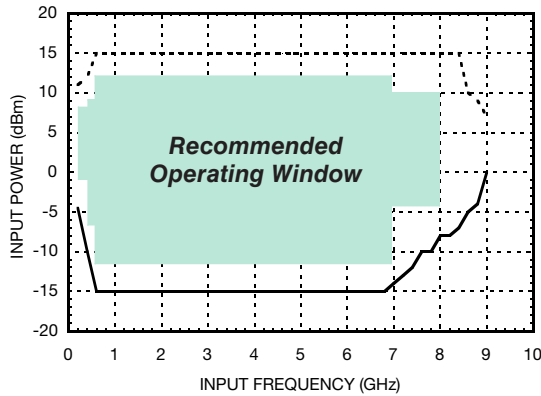
1. Divider will operate down to near DC.

2. For stable operation without an input signal, refer to Analog Devices Application Note, "Frequency Divider Operation & Compensation with No Input Signal."

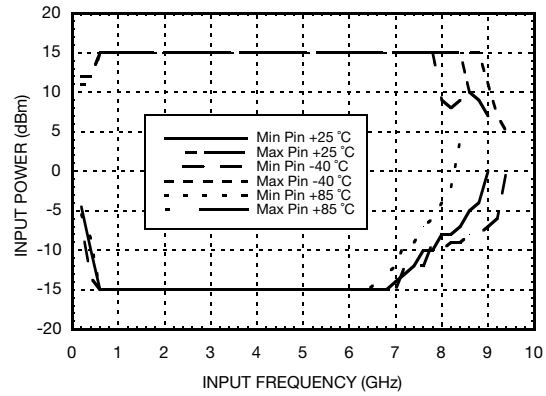


**SMT GaAs HBT MMIC  
DIVIDE-BY-2, DC - 8 GHz**

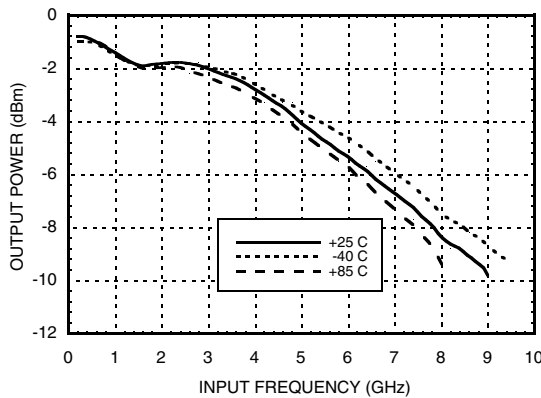
**Input Sensitivity Window, T = 25 °C**



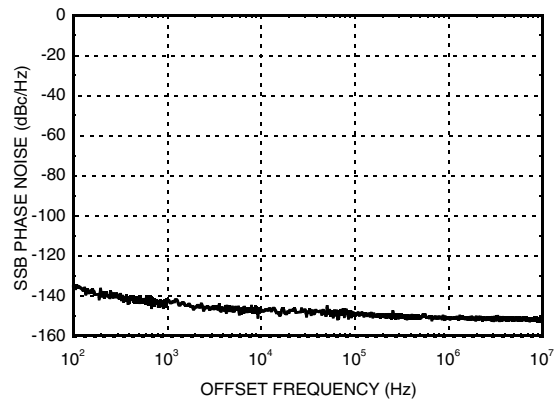
**Input Sensitivity Window vs. Temperature**



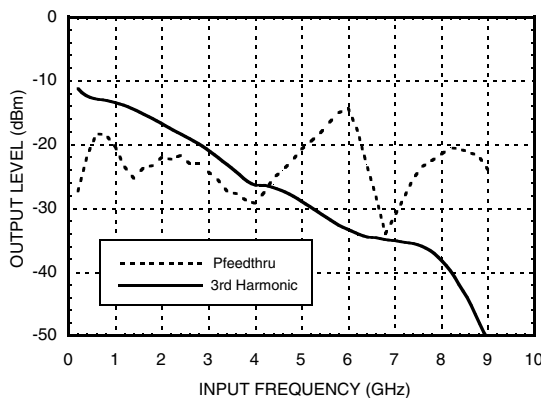
**Output Power vs. Temperature**



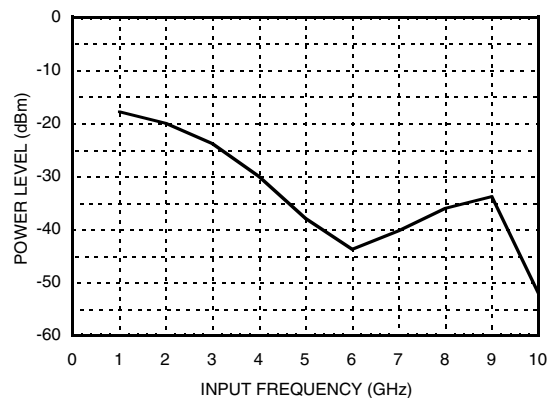
**SSB Phase Noise Performance,  
Pin = 0 dBm, T = 25 °C**



**Output Harmonic Content,  
Pin = 0 dBm, T = 25 °C**

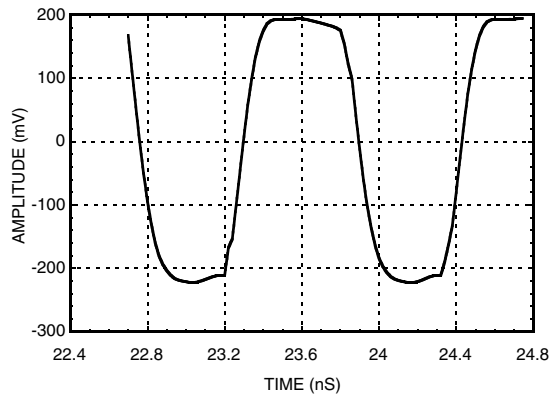


**Reverse Leakage, Pin = 0 dBm, T = 25 °C**





**Output Voltage Waveform,**  
*Pin = 0 dBm, Fout = 882 MHz, T = 25 °C*



**Absolute Maximum Ratings**

RF input power (Vcc = +3V)	15 dBm
Nominal +3V supply to GND	-0.3V to 3.5V
Max peak flow temperature	260 °C
Storage temperature	-65 °C to +125 °C
ESD sensitivity (HBM)	150 V

**Reliability Information**

Junction temperature to maintain 1 million hour MTTF	135 °C
Nominal junction temperature (T = 85 °C)	99 °C
Thermal resistance (Junction to GND paddle, 3V supply)	108 °C/W
Operating temperature	-40 to +85 °C

DC blocking capacitors are required at RF input and RF output ports. Choose value for lowest frequency of operation.

**Typical Supply Current vs. Vcc**

Vcc (V)	Icc (mA)
2.70	34
3.00	42
3.30	50

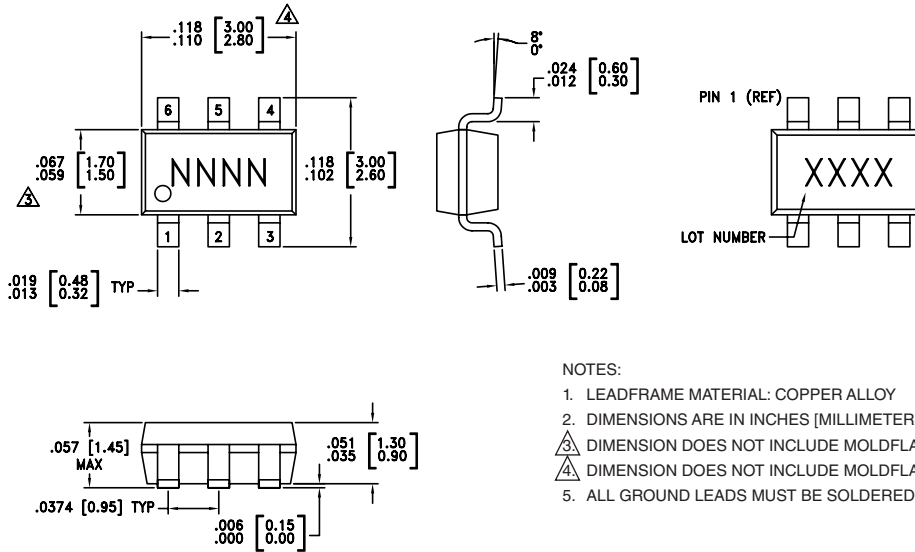
Note: Divider will operate over full voltage range shown above



**ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS**



### Outline Drawing



NOTES:


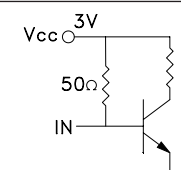
1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
3. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15 mm PER SIDE.
4. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25 mm PER SIDE.
5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

### Package Information

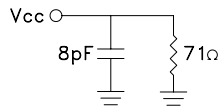
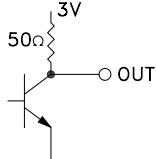
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[3]</sup>
HMC432	Low stress injection molded plastic	Sn/Pb solder	MSL1 <sup>[1]</sup>	H432 XXXX
HMC432E	RoHS-compliant low stress injection molded plastic	100% matte Sn	MSL1 <sup>[2]</sup>	432E XXXX

- [1] Max peak reflow temperature of 235 °C  
 [2] Max peak reflow temperature of 260 °C  
 [3] 4-digit lot number XXXX

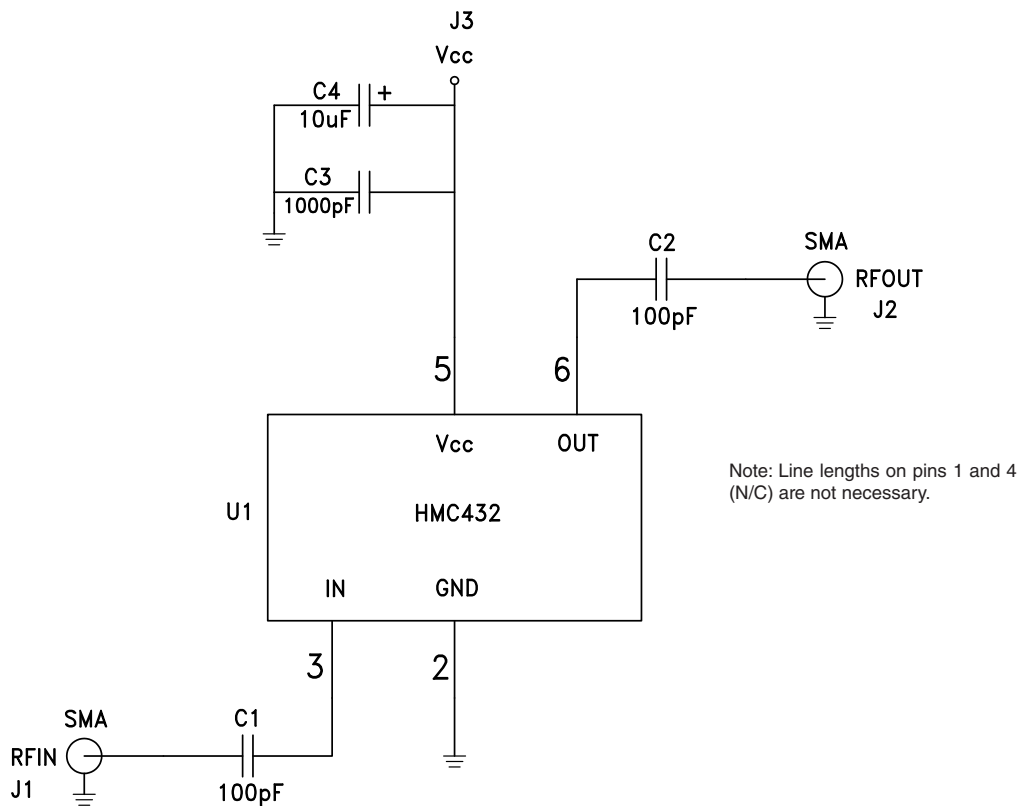
### Pin Description

Pin Number	Function	Description	Interface Schematic
1, 4	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
2	GND	Pin must connect to RF/DC ground.	
3	IN	RF input must be DC blocked.	

### Pin Description (Continued)

Pin Number	Function	Description	Interface Schematic
5	Vcc	Supply voltage 3V ±0.3V.	
6	OUT	Divided output must be DC blocked.	

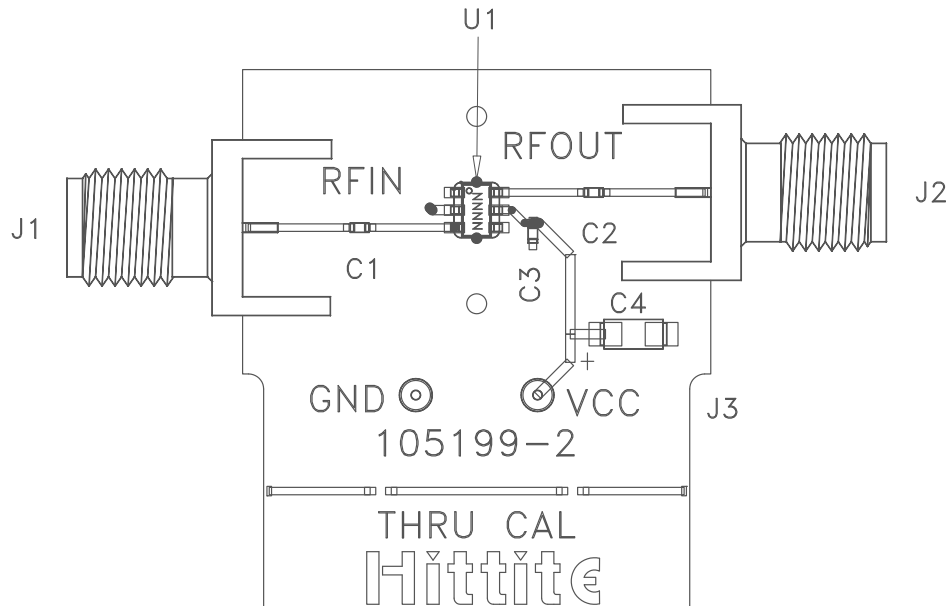
### Application Circuit



Note:

DC blocking capacitor values (C1, C2) and DC decoupling capacitor values (C3, C4) are chosen for lowest frequency of operation.

**Evaluation PCB**



**List of Materials for Evaluation PCB 105675 [1]**

Item	Description
J1 - J2	PCB mount SMA RF connector
J3 - J4	DC pin
C1 - C2	100 pF capacitor, 0402 pkg.
C3	1000 pF capacitor, 0402 pkg.
C4	10 µF tantalum capacitor, 1206 pkg.
U1	HMC432/HMC432E divide-by-2
PCB [2]	105199 eval board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit board material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ω impedance while the package ground leads should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.





Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.